Data sheet acquired from Harris Semiconductor SCHS235

CD74AC139, CD74ACT139

September 1998

Dual 2-to-4-Line Decoder/Demultiplexer

Features

- · Buffered Inputs
- Typical Propagation Delay
 - 5.4ns at $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 50pF$
- Exceeds 2kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST™/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
 - Fanout to 15 FAST™ ICs
 - Drives 50Ω Transmission Lines

Description

The CD74AC139 and CD74ACT139 are dual 2-to-4-line decoders/demultiplexers that utilize the Harris Advanced CMOS Logic technology. These devices contain two independent binary to one-of-four decoders, each with a single active LOW enable input ($\overline{1E}$ or $\overline{2E}$). Data on the select inputs (1A0 and 1A1 or 2A0 and 2A1) cause one of the four normally HIGH outputs to go LOW.

If the enable input is HIGH, all four outputs remain HIGH. For demultiplexer operation, the enable input is the data input. The enable input also functions as a chip select when these devices are cascaded.

Ordering Information

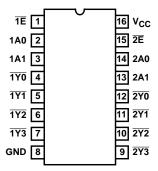
PART NUMBER	TEMP. RANGE (^o C)	PACKAGE	PKG. NO.
CD74AC139E	0 to 70 ^o C, -40 to 85, -55 to 125	16 Ld PDIP	E16.3
CD74ACT139E	0 to 70°C, -40 to 85, -55 to 125	16 Ld PDIP	E16.3
CD74AC139M96	0 to 70°C, -40 to 85, -55 to 125	16 Ld SOIC	M16.15
CD74ACT139M	0 to 70°C, -40 to 85, -55 to 125	16 Ld SOIC	M16.15

NOTES:

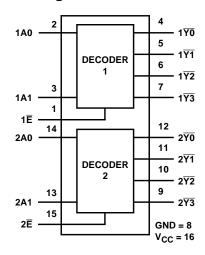
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local sales office or Harris customer service for ordering information.

Pinout

CD74AC139, CD74ACT139 (PDIP, SOIC) TOP VIEW



Functional Diagram



TRUTH TABLE

INP	UTS						
ENABLE	SEL	ECT	OUTPUTS				
Ē	A 1	A0	<u> </u>				
L	L	L	Н	Н	Н	L	
L	L	Н	Н	Н	L	Н	
L	Н	L	Н	L	Н	Н	
L	Н	Н	L	Н	Н	Н	
Н	Х	Х	Н	Н	Н	Н	

X = Don't Care

Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 6V
DC Input Diode Current, I _{IK}
For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$
DC Output Diode Current, I _{OK}
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V_{CC} or Ground Current, I_{CC} or I_{GND} (Note 3) ± 100 mA

Thermal Information

Thermal Resistance (Typical, Note 5)	θ_{JA} (oC/W)
PDIP Package	. 90
SOIC Package	. 160
Maximum Junction Temperature (Plastic Package)	150 ⁰ C
Maximum Storage Temperature Range	65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300 ^o C

Operating Conditions

55 ⁰ C to 125 ⁰ C
1.5V to 5.5V
4.5V to 5.5V
0V to V _{CC}
50ns (Max)
20ns (Max)
10ns (Max)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 3. For up to 4 outputs per device, add ± 25 mA for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

		1	TEST CONDITIONS V		25	°C		C TO °C		C TO 5°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
AC TYPES											
High Level Input Voltage	V _{IH}	-	-	1.5	1.2	-	1.2	-	1.2	-	V
				3	2.1	-	2.1	-	2.1	-	V
				5.5	3.85	-	3.85	-	3.85	-	V
Low Level Input Voltage	V _{IL}	-	-	1.5	-	0.3	-	0.3	-	0.3	V
				3	-	0.9	-	0.9	-	0.9	V
				5.5	-	1.65	-	1.65	-	1.65	V
High Level Output Voltage	V _{OH}	V _{IH} or V _{IL}	-0.05	1.5	1.4	-	1.4	-	1.4	-	V
			-0.05	3	2.9	-	2.9	-	2.9	-	V
			-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-4	3	2.58	-	2.48	-	2.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V

DC Electrical Specifications (Continued)

		TEST CONDITIONS		Vcc	V _{CC} 25		-40°C TO 85°C		-55°C TO 125°C		
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
Low Level Output Voltage	V_{OL}	V _{IH} or V _{IL}	0.05	1.5	-	0.1	-	0.1	-	0.1	V
			0.05	3	-	0.1	-	0.1	-	0.1	V
			0.05	4.5	-	0.1	-	0.1	-	0.1	V
			12	3	-	0.36	-	0.44	-	0.5	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	II	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	I _{CC}	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μΑ
ACT TYPES											
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-	2	-	2	-	V
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage	V _{OH}	V _{IH} or V _{IL}	-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	ı	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V
Low Level Output Voltage	V_{OL}	V _{IH} or V _{IL}	0.05	4.5	-	0.1	-	0.1	-	0.1	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	II.	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	I _{CC}	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μА
Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load	Δl _{CC}	V _{CC} -2.1	-	4.5 to 5.5	-	2.4	-	2.8	-	3	mA

NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum 50Ω transmission-line-drive capability at $85^{o}C$, 75Ω at $125^{o}C$.

ACT Input Load Table

INPUT	UNIT LOAD
A0, A1	1
Ē	0.67

NOTE: Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25°C.

Switching Specifications Input t_r , t_f = 3ns, C_L = 50pF (Worst Case)

			-40°	-40°C TO 85°C			-55°C TO 125°C			
PARAMETER	SYMBOL	V _{CC} (V)	MIN	TYP	MAX	MIN	TYP	MAX	UNITS	
AC TYPES				•						
Propagation Delay, A0, A1 to	t _{PLH} , t _{PHL}	1.5	-	-	119	-	-	131	ns	
Outputs		3.3 (Note 9)	3.9	-	13.4	3.7	-	14.7	ns	
		5 (Note 10)	2.8	-	9.5	2.6	-	10.5	ns	
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	119	-	-	131	ns	
Ē to Outputs		3.1	3.9	-	13.4	3.7	-	14.7	ns	
		5	2.8	-	9.5	2.6	-	10.5	ns	
Input Capacitance	Cl	-	-	-	10	-	-	10	pF	
Power Dissipation Capacitance	C _{PD} (Note 11)	-	-	83	-	-	83	-	pF	
ACT TYPES							•		•	
Propagation Delay, A0, A1 to Outputs	t _{PLH} , t _{PHL}	5 (Note 10)	3.1	-	10.5	2.9	-	11.5	ns	
Propagation Delay, E to Outputs	tPLH, tPHL	5	3.2	-	10.9	3	-	12	ns	
Input Capacitance	Cl	-	-	-	10	-	-	10	pF	
Power Dissipation Capacitance	C _{PD} (Note 11)	-	ı	83	-		83	-	pF	

NOTES:

- 8. Limits tested at 100%.
- 9. 3.3V Min at 3.6V, Max at 3V.
- 10. 5V Min at 5.5V, Max at 4.5V.

11. C_{PD} is used to determine the dynamic power consumption per decoder/demultiplexer. AC: $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ ACT: $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$ where f_i = input frequency, C_L = output load capacitance, V_{CC} = supply voltage.

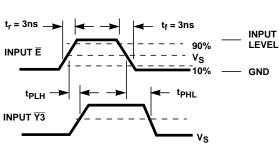
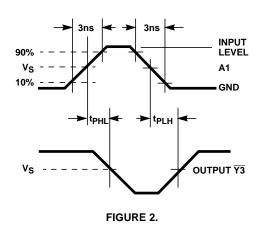
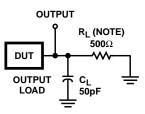


FIGURE 1.





NOTE: For AC Series Only: When V_{CC} = 1.5V, R_L = 1k Ω .

	CD74AC	CD74ACT
Input Level	V _{CC}	3V
Input Switching Voltage, V _S	0.5 V _{CC}	1.5V
Output Switching Voltage, V _S	0.5 V _{CC}	0.5 V _{CC}

FIGURE 3. PROPAGATION DELAY TIMES

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1999, Texas Instruments Incorporated